

Oki,	Network Solutions
	for a Global Society

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MSM7617

OKI Semiconductor

2-Channel Echo Canceler

GENERAL DESCRIPTION

The MSM7617 cancels echoes (acoustic or line echoes) generated in voice channels. It is a low-power CMOS LSI device with two channels.

MSM7617 echo canceling is performed by digital signal processing. It negates echoes by estimating the echo channel and then generating a pseudo-echo signal.

When used as an acoustic echo canceler, the MSM7617 can cancel acoustic echoes between speaker and microphone that occur during hands-free speaking with car phones, conferencing system phones, etc. When used as a line echo canceler, the MSM7617 can cancel line echoes returned by hybrid impedance mismatches.

By setting its mode for use as a single cross-connected channel, the MSM7617 can cancel both acoustic and line echoes.

Also, the MSM7617 can improve voice communication by using its howling detection, doubletalk detection, attenuation, and gain control functions to prevent and suppress howling levels, and by using its center clipping function to suppress low level noise.

Furthermore, the MSM7617 can disable echo canceling during data communication with its 2100 Hz tone detector and 2100 Hz phase reversal detector. It also provides the ability to attenuate SIN levels, to amplify SOUT levels, and to adjust input/output levels.

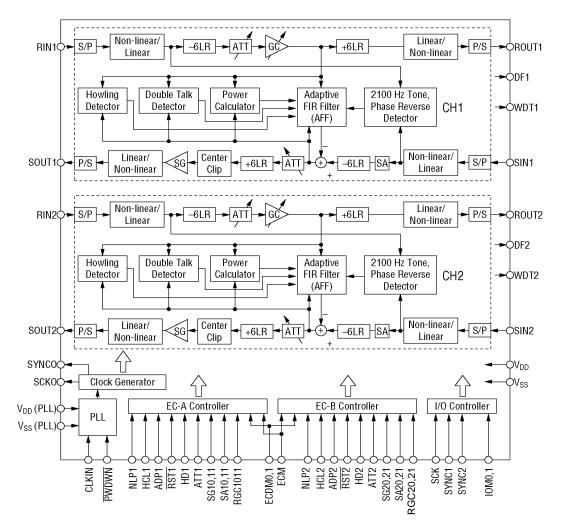
An economical and highly efficient echo canceler unit can be constructed by using a 2-channel single-chip CODEC like the MSM7533 together with the MSM7617.

FEATURES

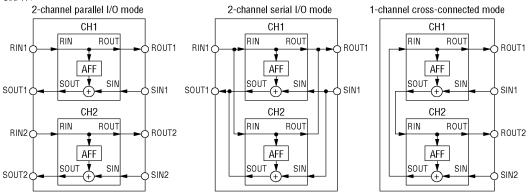
- Echo canceler has two channels, which can be used for acoustic and line echoes. Set as a single cross-connected channel, it can be used for both acoustic and line echoes.
- ITU-T G164/G165 standard tone disabler.
- PCM line level adjustment possible with SIN level attenuator (SA pin) and SOUT level amplifier (SG pin). Can also be used for ERL amplification with the SIN level attenuator (SA pin).
- RGC pin provides input/output adjustment mode (±6LR mode) that can prevent malfunction due to excessive inputs without changing the RIN-ROUT input/output levels.

•Cancelable echo delay time:	55 ms (max.)
•Echo attenuation:	30 dB (typ.)
•Clock frequency:	18 to 20 MHz 19.2 MHz if using internal clock signal
• Power supply voltage:	4.5 to 5.5 V
•Package:	64-pin plastic QFP (QFP64-P-1414-0.80-BK)
•Product name:	MSM7617-001GS-BK (μ-law)

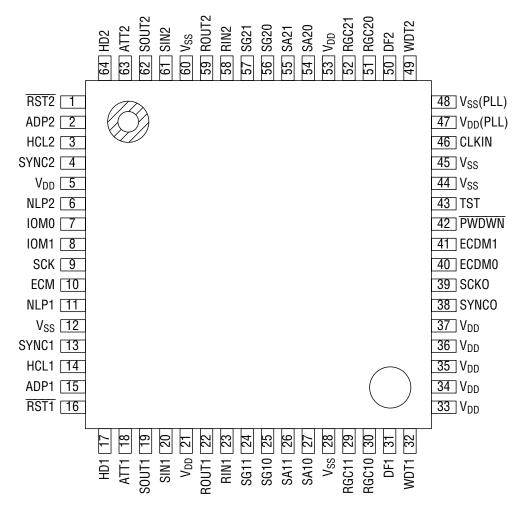
BLOCK DIAGRAM



The above diagram shows internal connections for 2-channel parallel mode. The internal connections for 2-channel serial I/O mode and 1-channel cross-connected mode are shown below.



PIN CONFIGURATION (TOP VIEW)



64-Pin Plastic QFP

PIN DESCRIPTIONS

Pin	Symbol	Туре	Description
1	RST2	1	Reset signal input pin for channel 2. "L": Reset "H": Normal operation Input signals are invalid for 100 μs after reset (after RST returns to "H" from "L") for setting initial values. Input the basic clock during reset. Output pins will be placed in the following states during reset. Hi-Z: ROUT2, SOUT2 No effect: SYNCO, SCKO, ROUT1, SOUT1, DF1, WDT1 Previous state: DF2, WDT2 At power-up, keep this pin to "L" longer than 1 μs after a master clock (CLKIN) gets stably supplied, and execute initialization of LSI internal registers by releasing it to "H". Also such as in a case when this LSI is intended to be kept in reset state, for instance, till the first call comes in, the above-mentioned initialization of LSI internal
			registers must be done, and, later than 560ns since the initialization, assert this pin back to "L" and wait the call.
2	ADP2	Ι	AFF coefficient control pin for channel 2. This pin stops coefficient variation of the adaptive FIR filter (AFF), fixing the coefficients. It allows once acquired AFF coefficients to be saved. "H": Fixed coefficient mode "L": Normal mode (variable coefficients)
3	HCL2	I	Echo canceler disable pin for channel 2. This pin disables the echo canceler and enables data from SIN to SOUT to be output in "through mode". The input and output levels of SIN and SOUT are changed by the setting of the SG and SA pins; therefore, to output data from SIN to SOUT in "through mode", set the SA and SG pins to "0 dB". It simultaneously clears the adaptive FIR filter coefficients. "H": Disable mode "L": Normal mode (echo canceller enabled)
4	SYNC2	Ι	Sync signal input pin for channel 2 transmit/receive PCM data while in parallel I/O mode. Input the transmit/receive sync signal (8 kHz) of the PCM CODEC connected to channel 2. Input "L" if not in parallel I/O mode.
6	NLP2	Ι	NLP control pin for channel 2. This pin controls center clipping, forcing SOUT2 output to the minimum positive value when it is below –54 dBm0. It is effective for reducing uncanceled echoes and low-level noise. "H": Center clipping on "L": Center clipping off

Pin	Symbol	Туре	Description					
7	IOM0	I	Sets I/	0 mode	of PCM data.			
8	IOM1		IOM1	IOM0	Mode Setting			
			0	0	2-channel parallel I/O mode			
			0	1	2-channel serial I/O mode			
			1	0	1-channel cross-connected mode			
			1	1	Inhibited			
9	SCK	I	transm	ission.	or channel 1 and channel 2. Clock input pin for PCM data clock as the transmit/receive clock of the PCM CODEC.			
					low 128 kHz cannot be used in serial mode.			
10	ECM		· ·		nput to "H".			
11	NLP1				n for channel 1.			
			This pin controls center clipping, forcing SOUT1 output to the minimum positive value when it is below -54 dBm0. It is effective for reducing uncancelled echoes and low-level noise. "H": Center clipping on "L": Center clipping off					
13	SYNC1	I	Sync signal input pin for channel 1 transmit/receive PCM data while in 2- channel parallel I/O mode, 2-channel serial I/O mode, or 1-channel cross- connected mode. Input the transmit/receive sync signal (8 kHz) of the PCM CODEC.					
14	HCL1	1	Echo canceler disable control pin for channel 1. This pin disables the echo canceler and enables data from SIN to SOUT to be output in "through mode". The input and output levels of SIN and SOUT are changed by the setting of the SG and SA pins; therefore, to output data from SIN to SOUT in "through mode", set the SA and SG pins to "0 dB". It simultaneously clears the adaptive FIR filter coefficients. "H": Disable mode "L": Normal mode (echo canceler enabled)					
15	ADP1	I	This pi coeffic "H": F	n stops (ients. It Fixed coe	control pin for channel 1. coefficient variation of the adaptive FIR filter (AFF), fixing the allows once acquired AFF coefficients to be saved. efficient mode node (variable coefficients)			

Pin	Symbol	Туре	Description
16	RST1	1	Reset signal input pin for channel 1. "L": Reset "H": Normal operation Input signals are invalid for 100 µs after reset (after RST returns to "H" from "L") for setting initial values. Input the base clock during reset. Output pins will be placed in the following states during reset. Hi-Z: ROUT1, SOUT1 No effect: SYNCO, SCKO, ROUT2, SOUT2, DF2, WDT2 Previous state: DF1, WDT1
			At power-up, keep this pin to "L" longer than 1 μ s after a master clock (CLKIN) gets stably supplied, and execute initialization of LSI internal registers by releasing it to "H". Also such as in a case when this LSI is intended to be kept in reset state, for instance, till the first call comes in, the above-mentioned initialization of LSI internal registers must be done, and, later than 560ns since the initialization, assert this pin back to "L" and wait the call.
17	HD1	I	Howling detection control pin for channel 1. This pin controls detection and canceling of howling generated by the acoustics of handsfree telephone. "L": Howling detector on "H": Howling detector off
18	ATT1	I	ATT control pin for channel 1. This pin controls the ATT function for preventing howling with the attenuators (ATT) provided on RIN and SOUT. When input is only on RIN, the SOUT attenuator is activated. When there is no input on RIN or there is input on both SIN and RIN, the RIN input attenuator is activated. Either the ATT for the RIN output or the ATT for the SOUT is always activated in all cases, and the attenuation of ATT is 6 dB. "H": Attenuator off "L": Attenuator on Because the attenuator is inserted opposite the speaker, it is effective for further reducing echo.
19	SOUT1	0	 PCM data output pin. Output signal changes depending on the setting of the IOM pins (refer to the block diagram). Data is always output on the rising edge of SCK. This pin is put in high impedance state while there is no data or during reset. In 2-channel parallel I/O mode, this pin becomes SOUT for channel 1 and outputs the PCM signal synchronous with SYNC1. In 2-channel serial I/O mode, this pin outputs the SOUT signal as a multiplexed PCM signal of SOUT signal for channel 1 and channel 2 synchronous with SYNC1. In 1-channel cross-connected mode, this pin becomes high impedance.

PIN DESCRIPTIONS (Continued)
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Pin	Symbol	Туре	Description
20	SIN1	1	PCM data input pin. Pin use changes depending on the setting of the IOM pins (refer to the block diagram). In 2-channel parallel I/O mode, this pin becomes SIN for channel 1 and inputs the PCM signal synchronous with SYNC1. In 2-channel serial I/O mode, this pin sequentially inputs SIN as a multiplexed PCM signal from channel 1 and channel 2 synchronous with SYNC1. In 1-channel cross-connected mode, this pin becomes the cross-connected SIN pin for channel 1, and inputs the PCM signal synchronous with SYNC1.
22	ROUT1	0	Data is captured on the falling edge of SCK. PCM data output pin. Output signal changes depending on the setting of the IOM pins (refer to the block diagram). Data is always output on the rising edge of SCK. This pin becomes high impedance while there is no data or during reset. In 2-channel parallel I/O mode, this pin becomes ROUT for channel 1 and outputs the PCM signal synchronous with SYNC1. In 2-channel serial I/O mode, this pin outputs the ROUT signal as a multiplexed PCM signal of ROUT signals for channel 1 and channel 2 synchronous with SYNC1. In 1-channel cross-connected mode, this pin becomes the cross-connected ROUT pin for channel 1, and outputs the PCM signal synchronous with SYNC1.
23	RIN1	1	PCM data input pin. Pin use changes depending on the setting of the IOM pins (refer to the block diagram). In 2-channel parallel I/O mode, this pin becomes RIN for channel 1 and inputs the PCM signal synchronous with SYNC1. In 2-channel serial I/O mode, this pin sequentially inputs RIN as a multiplexed PCM signal from channel 1 and channel 2 synchronous with SYNC1. In 1-channel cross-connected mode, this pin is not used, and should be fixed at "L". Data is captured on the falling edge of SCK.

PIN DESCRIPTIONS	(Continued)
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Pin	Symbol	Туре			Description		
24	SG11	I	S output gain control pins for channel 1 (refer to the block diagram).				
25	SG10		These pins amplify the output level of SOUT. The gain level can be set even				
			during	the echo	canceler disable mode.		
			SG11	SG10	Gain Level		
			0	0	0 dB		
			0	1	+6 dB		
			1	0	+12 dB		
			1	1	Not used		
26	SA11	I	S input	attenuat	or control pins for channel 1 (refer to the block diagram).		
27	SA10		These p	oins atten	uate the input level of SIN. Use them if ERL is large.		
			The atte	enuation	level can be set even during the echo canceler disable mode		
			SA11	SA10	Attenuation Level		
			0	0	0 dB		
			0	1	-6 dB		
			1	0	-12 dB		
			1	1	Not used		
29	RGC11	I	R input	level con	trol pins for channel 1 (refer to the block diagram).		
30	RGC10		Excessiv	ve input (PCM level is at maximum value) causes a malfanction.		
			Use these pins when there is a possibility of excessive input.				
			RGC11	RGC10	Level Control Mode		
			0	0	Off		
			0	1	GC: On (control level = -20 dBm0)		
					By the R gain controller, levels from –20 to –11.5 dBm0 will		
					be suppressed to –20 dBm0 and those above –11.5 dBm0 wil		
					always be attenuated by 8.5 dB. This is effective to prevent		
					excessive input and howling for hands-free applications.		
			1	0	Inhibited		
			1	1	±6LR: On		
					Applies –6 dB to excessive inputs using the level adjuster		
					provided on R and S I/O. Since +6 dB also is applied at the		
					output, the total level will not change, making this effective		
					against line echo.		

Pin	Symbol	Туре			Description					
31	DF1	0	Tone disabler flag output pin for channel 1.							
			This pin outputs a disable flag when the ECDM pins are used for tone disabler							
			mode.							
			"H": Echo canceler disabled							
			-	"L": Echo canceler enabled						
32	WDT1	0	Not use	ed. Leav	e this pin open.					
38	SYNCO	0		•	nternal SYNC signal (8 kHz).					
					as the transmit/receive synchronization signal for PCM signals.					
					e SYNC pin and PCM CODEC's synchronization signal pin. Leave					
	001/0				using an external SYNC.					
39	SCKO	0		•	nternal SCK signal (256 kHz).					
					for the transfer clock of PCM signals. Connect it to the PCM nonization signal pin. Leave open if using an external SYNC.					
40	ECDM0	1			ontrol pin common to channel 1 and channel 2.					
40 41	ECDM0 ECDM1				ect answer tones generated by modems (2100 Hz), and then					
41	LODIVIT				canceler. Once the echo canceler is disabled by this function, the					
					s kept disabled unless the power of its received signals gets less					
					ndependently upon the frequency characteristics of its received					
			signals							
			ECDM1	ECDM0	Tone Disabler Mode					
			0	0	Off					
			0	1	2100Hz tone detection: ON					
					(detects both phase reversed and non-phase reversed 2100Hz)					
			1	0	Phase reversed 2100Hz tone detection: ON					
					(detects only phase reversed 2100Hz)					
			1	1	Inhibited					
42	PWDWN	I	Commo	on pin fo	r channel 1 and channel 2.					
			This pin controls the power-down mode to reduce current consumption when the							
			device is not being used.							
			"L": Power down							
			"H": Normal operation							
			During power-down mode all input pins are invalid, and output pins will enter the							
			following states. Hi-Z: SOUT1, SOUT2, ROUT1, ROUT2							
			"L": SYNCO, SCKO							
					DF1, WDT1, DF2, WDT2					
			Reset t	he devic	e after power-down mode is released.					

Pin	Symbol	Туре			Description			
43	TST	0	Not used	I. Leave th	nis pin open.			
46	CLKIN	I	Basic clock input pin.					
			Input a clock 18 to 20 MHz. Use 19.2 MHz if using internal synchronizatio signals (SYNCO, SCKO).					
47	V _{DD}	1	Power s	Power supply for PLL circuit that uses the basic clock.				
	(PLL)		Insert a	Insert a $0.1 \mu F$ capacitor with excellent high frequency characteristics				
			between	V _{DD} (PLL) and V _{SS} (PLL).			
48	V _{SS}	1	Ground	for PLL ci	rcuit that uses the basic clock.			
	(PLL)		Insert a	0.1µF cap	acitor with excellent high frequency characteristics			
			between	V _{DD} (PLL) and V _{SS} (PLL).			
49	WDT2	0	Not used	Not used. Leave this pin open.				
50	DF2	0	Tone dis	abler flag	output pin for channel 2.			
			This pin	outputs a	disable flag when the ECDM pins are used for tone			
			disabler.					
			"H": Echo canceler disabled					
			"L": Echo canceler enabled					
51	RGC20	1	R input level control pins for channel 2 (refer to the block diagram).					
52	RGC21		Excessiv	re input (F	PCM level is at maximum value) causes a malfunction.			
			Use thes	e pins wh	nen there is a possibility of excessive input.			
			RGC21	RGC20	Level Control Mode			
			0	0	Off			
			0	1	GC: On (control level = -20 dBm0)			
					By the R gain controller, levels from -20 to -11.5 dBm0			
					will be suppressed to -20 dBm0 and those above -11.5			
					dBm0 will always be attenuated by 8.5 dB. This is			
					effective to prevent excessive input and howling for			
					hands-free applications.			
			1	0	Inhibited			
			1	1	±6LR: On			
					Apply –6 dB to excessive inputs using the level			
					adjuster provided on R and S I/O. Since +6 dB also			
					is applied at the output, the total level will not			
					change, making this effective against line echo.			

Pin	Symbol	Туре			Description		
54	SA20	I	S input attenuator control pins for channel 2 (refer to the block diagram).				
55	SA21		These pi	ns attenu	ate the input level of SIN. Use them if ERL is large.		
			The atte	nuation le	vel can be set even during the echo canceler disable mode		
			SA21	SG20	Attenuation Level		
			0	0	0 dB		
			0	1	-6 dB		
			1	0	-12 dB		
			1	1	Not used		
56	SG20	I	S output	gain con	trol pins for channel 2 (refer to the block diagram).		
57	SG21		These pi	ns amplif	y the output level of SOUT. The gain level can be set even		
			during tl	ne echo ca	anceler disable mode.		
			SG21	SG20	Gain Level		
			0	0	0 dB		
			0	1	+6 dB		
			1	0	+12 dB		
			1	1	Not used		
58	RIN2	I	PCM dat	ta input pi	in. Pin use changes depending on the setting of the IOM		
			pins (refer to the block diagram).				
			In 2-channel parallel I/O mode, this pin becomes RIN for channel 2 and				
			inputs the PCM signal synchronous with SYNC2. Data is captured on the				
			falling edge of SCK. In other modes, this pin is not used, and should be				
			fixed at '	'L".			
59	ROUT2	0	PCM dat	ta output	pin. Output signal changes depending on the setting of		
			the IOM pins (refer to the block diagram).				
			Data is always output on the rising edge of SCK. This pin becomes high				
			impedance while there is no data.				
			In 2-channel parallel I/O mode, this pin becomes ROUT for channel 2 and				
			outputs the PCM signal synchronous with SYNC2. In 2-channel serial I/O				
			mode, this pin is not used and should be left open. In 1-channel cross-				
			connected mode, this pin becomes the cross-connected ROUT pin for				
			channel	2, and ou	tputs the PCM signal synchronous with SYNC1.		

Pin	Symbol	Туре	Description
61	SIN2	I	PCM data input pin. Pin use changes depending on the setting of the IOM
			pins (refer to the block diagram). Data is captured on the falling edge of SCK
			In 2-channel parallel I/O mode, this pin becomes SIN for channel 2 and
			inputs the PCM signal synchronous with SYNC2. In 2-channel serial I/O
			mode, this pin is not used and should be fixed at "L". In 1-channel cross-
			connected mode, this pin becomes the cross-connected SIN pin for channe
			2, and inputs the PCM signal synchronous with SYNC1.
62	SOUT2	0	PCM data output pin. Output signal changes depending on the setting of
			the IOM pins (refer to the block diagram).
			Data is always output on the rising edge of SCK. This pin becomes high
			impedance while there is no data.
			In 2-channel parallel I/O mode, this pin becomes SOUT for channel 2 and
			outputs the PCM signal synchronous with SYNC2. In other modes, this pin
			is not used and should be left open.
63	ATT2	I	ATT control pin for channel 2.
			This pin controls the ATT function for preventing howling with the
			attenuators (ATT) provided on RIN and SOUT. When input is only on RIN,
			the SOUT attenuator is activated. When there is no input on SIN or there is
			input on both SIN and RIN, the RIN input attenuator is activated. Either the
			ATT for the RIN output or the ATT for the SOUT is always activated in all
			cases, and the attenuation of ATT is 6 dB.
			"H": Attenuator off
			"L": Attenuator on
			Because the attenuator is activated opposite the speaker, it is effective for
			further reducing echo.
64	HD2	I	Howling detection control pin for channel 2.
			This pin controls detection and canceling of howling generated by the
			acoustics of handsfree telephones.
			"L": Howling detector on
			"H": Howling detector off

Parameter	Symbol	Condition	Rating	Unit
Power Supply Voltage	V _{DD}		-0.3 to + 7	V
Input Voltage	V _{IN}	Ta = 25°C	-0.3 to V _{DD} + 0.3	V
Power Dissipation	PD		1	W
Storage Temperature	T _{STG}	_	-55 to +150	°C

ABSOLUTE MAXIMUM RATINGS

RECOMMENDED OPERATING CONDITIONS

					$(V_{DD} = 4.5)$	to 5.5 V)
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	V _{DD}	_	4.5	5	5.5	V
Power Supply Voltage	V _{SS}	—	_	0	_	V
High Level Input Voltage	V _{IH}	Other input pins than SYNC1/2, SCK	2.4	_	V _{DD}	V
		SYNC1/2, SCK	$V_{DD}\!\times\!0.8$		V _{DD}	
Low Level Input Voltage	VIL	—	0		0.8	V
Operating Temperature	Та	—	-40	+25	+85	°C

ELECTRICAL CHARACTERISTICS

DC Characteristics

		(V _{DC}) = 4.5 V to	5.5 V, Ta =	= –40°C to	+85°C)
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
High Level Output Voltage	V _{OH}	I _{OH} = 40 μA	4.2		V_{DD}	V
Low Level Output Voltage	V _{OL}	I _{OL} = 1.6 mA	0		0.4	V
High Level Input Current	I _{IH}	$V_{IH} = V_{DD}$	—	0.1	10	μA
Low Level Input Current	١ _{١L}	$V_{IL} = V_{SS}$	-10	-0.1	—	μA
High Level Output Leakage Current	I _{OZH}	$V_{OH} = V_{DD}$	_	0.1	10	μA
Low Level Output Leakage Current	I _{OZL}	$V_{OL} = V_{SS}$	-10	-0.1	—	μA
Power Supply Current (operation mode)	I _{DDO}	—	—	80	130	mA
Power Supply Current (power-down mode)	I _{DDS}	PWDWN = "L"	—	0.5	2	mA
Input Capacitance	CI	_	_		15	pF
Output Load Capacitance	CLOAD		_	_	20	рF

Echo Canceler Characteristics	(refer to characteristics diagram)
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Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
		R _{IN} = -10 dBm0				
Echo Reduction		(5 kHz white noise band)				
	L _{RES}	E. R. L. = 6 dB	_	30	_	dB
(Common to Channel 1 and		T _D = 50 ms				
Channel 2)		ATT, GC, NLP: OFF				
		R _{IN} = -10 dBm0				
Cancelable Echo Delay Time		(5 kHz white noise band)			55	
(Common to Channel 1 and	TD	E. R. L. = 6 dB	_		55	ms
Channel 2)		ATT, GC, NLP: OFF				

Tone Disabler Characteristics

Para	Min.	Тур.	Max.	Unit	
	Detection frequency	2075	2100	2125	Hz
Tone Detection	Detection level	-32	_		dBm0
	Detection time	380	_		ms
	Detection condition 2100Hz. 180° out-of-phase detected before and after 45			fter 450±25ms.	
Dhana Davaraal Datastian	Detection frequency	2075	2100	2125	Hz
Phase Reversal Detection	Detection level	-32	_		dBm0
	Phase reversal	135	180	225	0
Deleges	Detection level	_	_	-32	dBm0
Release	Release time	_	250	_	ms

AC Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit
Clock Frequency	4		19.2		MHz
If Used Without Internal Sync Signal	f _C	18	_	20	
Clock Cycle Time	+		52.08		
If Used Without Internal Sync Signal	t _{MCK}	50	_	55.56	ns
Clock Duty Cycle	t _{DMC}	40	—	60	%
Clock High Level Pulse Width	t _{MCH}	$t_{MCK} imes 0.4$	—	$t_{MCK} \times 0.6$	ns
Clock Low Level Pulse Width	t _{MCL}	$t_{MCK} imes 0.4$	—	$t_{MCK} imes 0.6$	ns
Clock Rise Time	t _r	—	—	5	ns
Clock Fall Time	t _f	_	—	5	ns
Internal Sync Clock Output Time	t _{DCM}	_	—	40	ns
Internal Sync Clock Frequency	f _{CO}	_	256	_	kHz
Internal Sync Clock Cycle Time	t _{CO}	_	3.9	_	μs
Internal Sync Clock Duty Cycle	t _{DCO}	_	50	_	%
Internal Sync Signal Output Time	t _{DCC}	_	_	5	ns
Internal Sync Signal Period	t _{CYO}	_	125	_	μs
Internal Sync Signal Pulse Width	t _{WSO}	_	t _{CO}	_	μs
Transmit/Receive Sync Clock Frequency	f	64	—	2048	
In Serial I/O Mode	fscк	128	—	2048	kHz
Transmit/Receive Sync Clock Cycle Time	t	0.488	—	15.62	
In Serial I/O Mode	tscк	0.488	—	7.81	μs
Transmit/Receive Sync Clock Duty Cycle	t _{DSC}	40	50	60	%
Transmit/Receive Sync Signal Period	t _{CYC}	—	125	—	μs
Suno Timing	t _{XS}	45	—	—	ns
Sync Timing	t _{SX}	45	—	_	ns
Sync Signal Width	t _{WSY}	t _{SCK}	—	t _{CYC} -t _{SCK}	μs
Receive Signal Setup Time	t _{DS}	45	_	_	ns
Receive Signal Hold Time	t _{DH}	45	_		ns
Receive Signal Input Time	t _{ID}		7t _{SCK}	_	μs
In 2-Channel Serial Mode	t _{ID2}	_	15t _{SCK}		μs

 $(V_{DD} = 4.5 \text{ V to } 5.5 \text{ V}, \text{ Ta} = -40^{\circ}\text{C to } +85^{\circ}\text{C})$

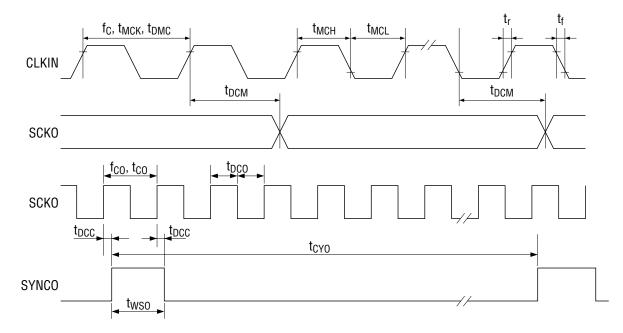
AC Characteristics (Continued)

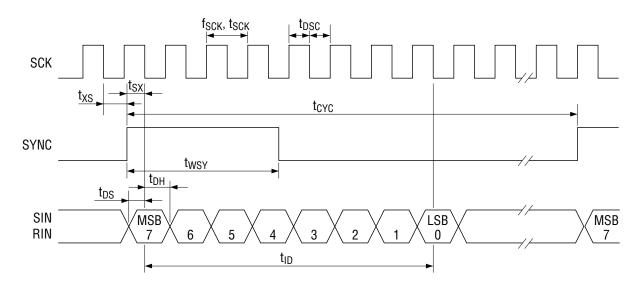
		$(V_{DD} = 4.5 \text{ V to } 5.5 \text{ V}, \text{ Ia} = -40^{\circ}\text{C to } +85^{\circ}\text{C})$					
Parameter	Symbol	Min.	Тур.	Max.	Unit		
Social Output Dalay Time	t _{SD}	—	_	90	ns		
Serial Output Delay Time	t _{XD}	—	—	90	ns		
Reset Signal Input Width	t _{WR}	1	_	_	μs		
Reset Start Time	t _{DRS}	5	_	—	ns		
Reset End Time	t _{DRE}	_	_	52	ns		
Process Operation Start Time	t _{DIT}	100			μs		
Power-Down Start Time	t _{DPS}	_		111	ns		
Power-Down End Time	t _{DPE}	_		15	ns		
RST Width After Power-Down	t _{WPR}	10			μs		
RST Control Pin Setup Time	t _{DSR}	20	_		ns		
RST Control Pin Hold Time	t _{DHR}	20			ns		
SCK Control Pin Setup Time	t _{DCS}	120	_	_	ns		
SCK Control Pin Hold Time	t _{DCH}	120	_		ns		

$(V_{DD} = 4.5 \text{ V to } 5.5 \text{ V}, \text{ Ta} = -40^{\circ}\text{C to } +85^{\circ}\text{C})$

TIMING DIAGRAMS

Clock Timing

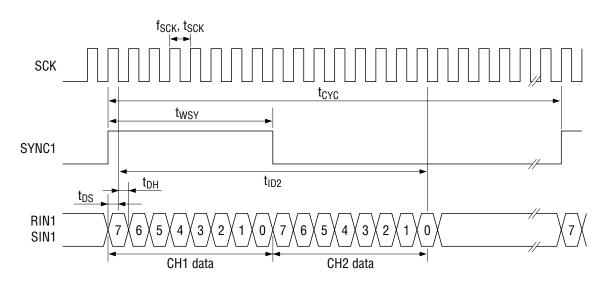


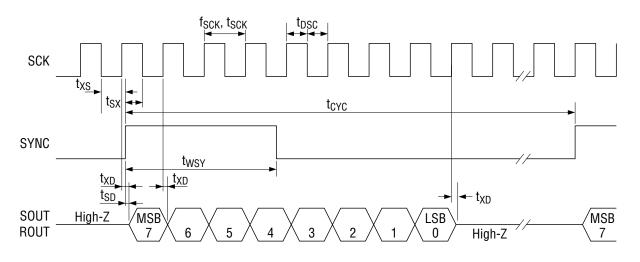


Serial Data Input Timing (Parallel Mode, FTF Mode)

Serial Data Input Timing (Serial Mode)

Note: Refer to parallel mode for detailed timing

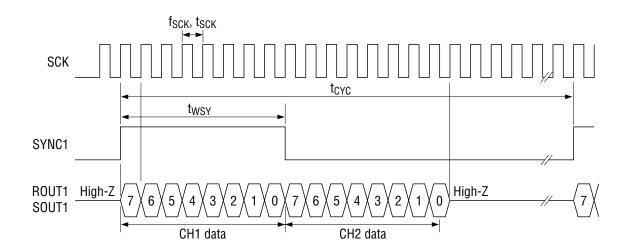




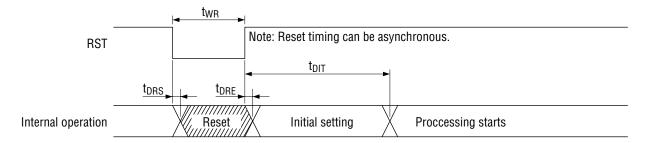
Serial Data Output Timing (Parallel Mode, FTF Mode)

Serial Data Output Timing (Serial Mode)

Note: Refer to parallel mode for detailed timing

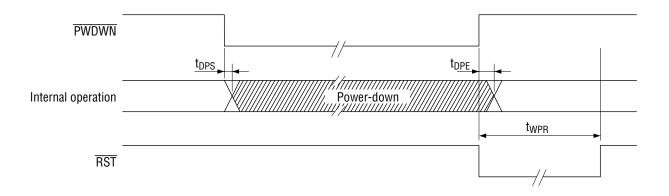


Operation Timing After Reset



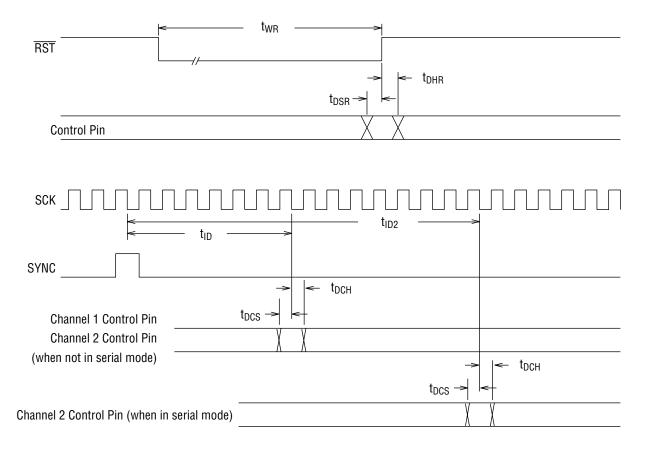
Power-Down Timing

Note: All inputs are invalid during power-down. Always reset the device after power-down.



Capture Timing of Control Pins

Control pin states are captured during reset and during each period's serial data capture.

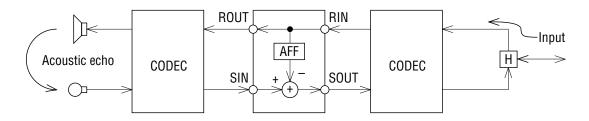


HOW TO USE THE MSM7617

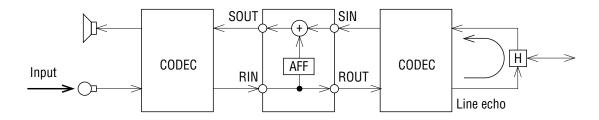
The echo canceler cancels the echo on the RIN signal as returned by SIN. Connect the original signal to the R side, and the signal generating the echo to the S side.

Connection Methods According to Echoes

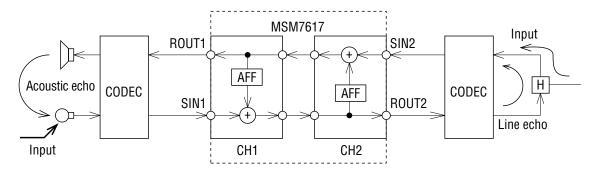
Example 1. Cancel Acoustic Echo (applies to acoustic echo from line input)



Example 2. Cancel Line Echo (applies to line echo from microphone input)

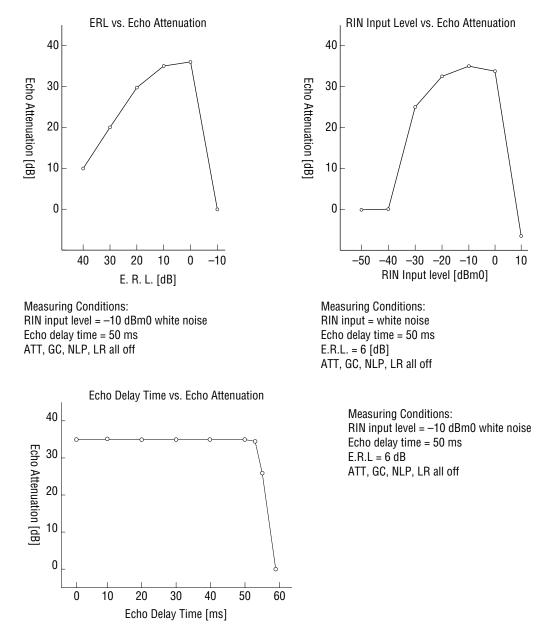


Example 3. Cancel Both Acoustic Echo And Line Echo



ECHO CANCELER CHARACTERISTICS DIAGRAM

Characteristics of μ -law and A-law are identical. (Characteristic graphs below are reference data.)

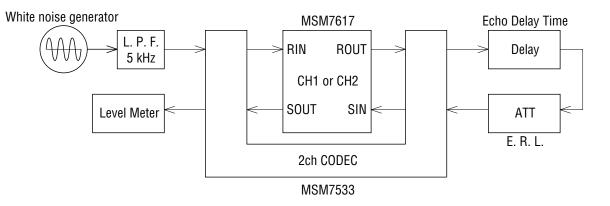


Note: regarding dBm0:

The "dBm0" unit used in the characteristic graphs is a unit that expresses PCM CODEC digital values. Therefore, be aware that the same value 0 [dBm0] might correspond to different analog input levels depending on the PCM CODEC being used. Please check the data sheet of the PCM CODEC being used.

Example	MSM7533	$0 \text{ [dBm0]} = 0.85 \text{ [Vrms]} = 2.4 \text{ [Vp-p]} = 0.8 \text{ [dBm]} 600 \Omega$ -10 [dBm0] = 0.27 [Vrms] = 0.76 [Vp-p] = -9.2 [dBm] 600 \Omega
	MSM7543	0 [dBm0] = 0.6007 [Vrms] = 1.7 [Vp-p] = -2.2 [dBm] 600 Ω -10 [dBm0] = 0.19 [Vrms] = 0.54 [Vp-p] = -12.2 [dBm] 600 Ω

Measurement System Block Diagram



NOTES ON USE

1. Set echo return loss (E. R. L) to be attenuated. If the echo return loss is set to be amplified, the echo cannot be canceled. (Refer to the "E. R. L vs Echo Attenuation" characteristic graph.)

When the echo return loss is amplified, adjust the input level to be attenuated by setting the mode with the SA pin. If the level from the SA pin is too low by setting the mode with the SA pin, then amplify the output level by setting the mode with the SG pin.

2. Set RIN input so that there is not excessive input (above 0 dBm0) from the PCM CODEC. Echo cancellation is not possible with excessive input. (Refer to the "RIN vs Echo Attenuation" characteristic graph.)

Recommended input levels are –10 to –20 dBm0. If there is a possibility of excessive input, then set GC mode or 6LR mode with the RGC pins.

- 3. Applying the tone signals to this echo canceler will decrease echo attenuation.
- For changes in the echo path (retransmit, circuit switching during transmission, and so on), convergence may be difficult. Perform a reset to make it converge.

If the state of the echo path changes after a reset, convergence may again be difficult. In cases such as a change in the echo path, perform a reset each time.

5. If a clock is not input after power is applied, then the internal circuits will not stabilize, possibly damaging the device.

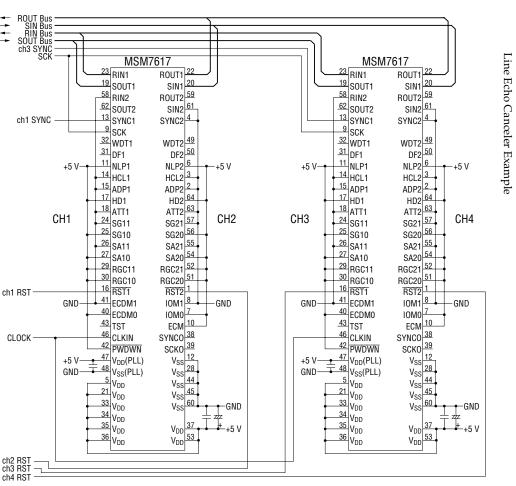
When power is applied, set the <u>PWDWN</u> pin to "H" and input the basic clock.

If the device is put into <u>PWDWN</u> immediately after power has been applied, be sure to input 10 or more clocks of the basic clock before setting to the power down mode.

- 6. Always reset after power is applied or power-down is released. For power-on reset operation, an external oscillator may require a certain setting time after powered on. Allow 10 μs for a reset time after the oscillator has settled.
- 7. When the device is used as an acoustic echo canceler, equipment noise and environment noise from the microphone amp may be amplified, and echo attenuation may be below 30 dB.

APPLICATION CIRCUITS

4-Channel Serial Interface

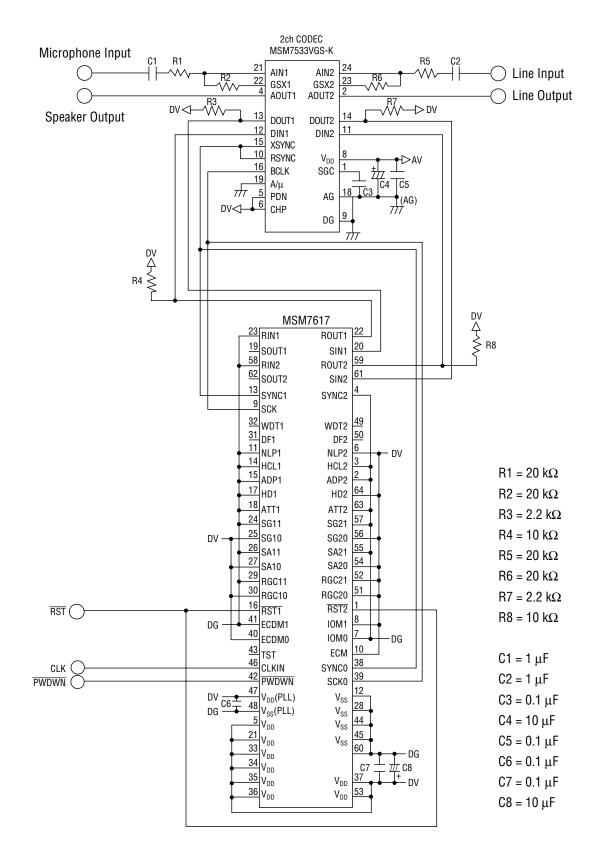


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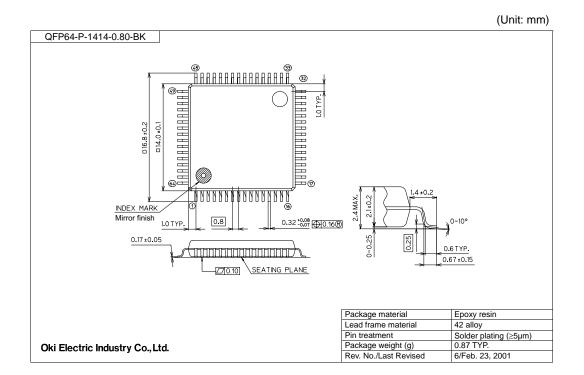
Downloaded from Elcodis.com electronic components distributor

Line side — Terminal side —

Cross-Connection Example



PACKAGE DIMENSIONS



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

REVISION HISTORY

Document		Page			
No.	Date	Previous Edition	Current Edition	Description	
FEDL7617-04	Nov. 2001	_	-	Edition 4	
			3	Typo correction of "RGC20,21" from "GC20,21"	
FEDL7617-05 Jun. 27, 200		5	5	Correction and addition in power-up sequence in RST2 pin description	
	Jun. 27, 2003	7	7	Correction and addition in power-up sequence in RST1 pin description	
		10	10	Alternation in expressions to eliminate ambiguity in ECDM0/ECDM1 pin description	
		14	14	Separation of V_{IH} specifications for SYNC1/2 and SCK pins	

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